

Features and Benefits

- 6 V to 45 V input range
- DC-to-DC buck converter with 5.7 V output
- Overcurrent protection with foldback, and undervoltage lockout (UVLO)
- Dual 5 V outputs
 - Digital 5 V ±2%, 200 mA
 - Analog 5 V, 200 mA
 - Short-to-supply protection on analog regulator
 - Analog to digital regulator output tracking < 0.5% throughout operating temperature range

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Package: 24 pin SOIC (suffix LB)



Not to scale

Description

The A8450 is a multioutput power supply intended for automotive applications. The A8450 operates from a wide input supply range and is designed to satisfy the requirements of high ambient temperature environments.

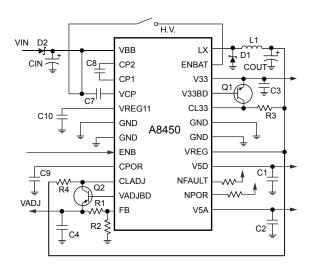
Four regulated voltage outputs provide multiple options. The 3.3 V regulator and the 1.2 to 3.3 V adjustable regulator can be used to power microcontroller or DSP cores, or for I/O, sensing, and A-to-D conversion. Two 5 V outputs, one digital and the other analog, feature output tracking within 0.5% of each other over the operating temperature range. In addition, the analog regulator is protected against short-to-battery conditions. All four regulators feature foldback current limit protection.

The device can be enabled or disabled using two input pins. The high voltage input, on the ENBAT pin, allows enable/disable using an engine ignition or battery switch signal. The logic-level input, on the ENB pin, allows enable/disable by microcontroller or DSP signals.

When disabled, the A8450 draws less than $10 \mu A$ of current. A POR (power-on-reset) block monitors the supply voltages and provides a reset signal, with an adjustable delay, for

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Typical Application



A8450

Automotive Multioutput Voltage Regulator

Features and Benefits (continued)

- 3.3 V linear regulator, with foldback current limit
- Adjustable 1.2 V to 3.3 V linear regulator, adjustable foldback current limit
- Ignition switch enable; Sleep mode
- 100% duty cycle operation for low input voltages
- Power OK output
- -40°C to 135°C ambient operating temperature range

Description (continued)

microcontroller or DSP resets. A separate fault pin signals TSD (thermal shutdown), 5 V analog short-to-supply, and 5 V analog or digital undervoltage.

The A8450 is supplied in a 24-pin SOIC-W package (part number suffix LB) with internally-fused power ground pins for enhanced thermal performance. This provides an $R_{\theta JA}$ of 35°C/W on a 4-layer board (see chart on p. 5). The lead (Pb) free version has 100% matte tin leadframe plating.

Selection Guide

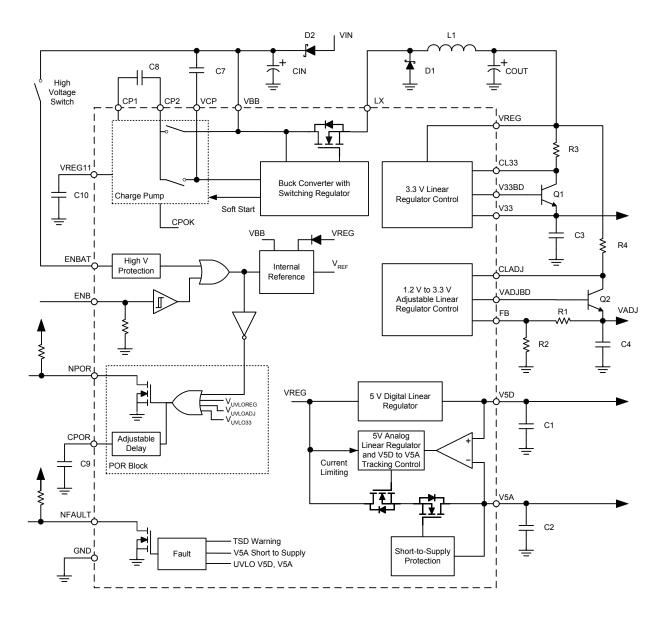
| ı | Part Number | Pb-free | Packing | Terminals | Package |
|---|-------------|---------|-----------------------------|-----------|---|
| A | 8450KLBTR-T | Yes | 1000 pieces per 13-in. reel | 24 | SOIC-W surface mount, internally fused power ground pins (6-7, 18-19) |

Absolute Maximum Ratings

| Parameter | Symbol | Conditions | Rating | Units |
|-----------------------------|----------------------------------|-----------------|-----------------------|-------|
| Load Supply Voltage | V _{BB} | VBB pin | - 40 | V |
| Analog Output | V _{5A} | V5A pin | -1 to 45 | V |
| Logic Input Cignal | V _{ENBAT} | ENBAT pin input | -0.3 to 45 | V |
| Logic Input Signal | V _{ENB} | ENB pin input | -0.3 to 6.5 | V |
| LX Voltage | V _{LX} | LX pin | –2 to V _{BB} | V |
| Operating Temperature Range | T _A | K range | -40 to 135 | °C |
| Junction Temperature | T _J (max ₎ | | 150 | °C |
| Storage Temperature Range | T _{stg} | | -55 to 150 | °C |



Functional Block Diagram



| ID | Characteristics | Representative Device | |
|------------------------------|--|-----------------------|--|
| C1, C2, C3, C4 | 1 μF, 25 V ceramic X7R | | |
| COUT | 100 μF, 35 V low-ESR electrolytic | UHC1V101M, Nichicon | |
| CIN | 47 μF, 63 V electrolytic | | |
| C7, C8 | 0.1 μF, 50 V ceramic X7R (for 14 V applications), or | | |
| C7, C8 | 0.1 μF, 100 V ceramic X7R (for 42 V applications) | | |
| C10 | 0.22 μF, 10 V X7R | | |
| D1, D2 | 1 A, 40 V Schottky (for 14 V applications) | EKO4, Sanken | |
| L1 100 µH, 1.2 A D03316H | | D03316HT, Coilcraft | |
| Q1, Q2 pass transistors | npn transistor, h _{FE} > 50 | MPSW06 | |



ELECTRICAL CHARACTERISTICS at $T_A = -40$ °C to 135°C, $V_{BB} = 6$ to 45 V, $V_{ENB} = 5$ V, unless otherwise noted

| Characteristics | Symbol | Test Conditions | Min. | Тур. | Max. | Units |
|-----------------------------|------------------------|--|-------|-------|-------|-------|
| | | Enabled mode: V_{ENBAT} or V_{ENB} = HIGH, I_{OUT} = 0 mA: V_{BB} = 14 V | _ | 6 | 10 | mA |
| Supply Quiescent Current | I _{BB} | Enabled mode: V_{ENBAT} or V_{ENB} = HIGH, I_{OUT} = 0 mA; V_{BB} = 6 V | _ | 10 | 15 | mA |
| | | Disabled mode: V _{ENBAT} and V _{ENB} = LOW | _ | - | 10 | μΑ |
| Regulated Output Voltage | V _{REG} | I _{LOAD} = 550 mA = I _{LOADV5D} + I _{LOADV5A} + I _{LOADV33} + I _{LOADVADJ} ; V _{BB} > 6.5 V | 5.50 | _ | 5.80 | V |
| | | Dropout: 6 V ≤ V _{BB} < 6.5 V | 5.00 | _ | 5.80 | V |
| Buck Switch On-Resistance | R _{DSON} | T _J = 25°C | _ | 415 | 500 | mΩ |
| | . 1050N | T _J = 135°C | _ | 650 | 750 | mΩ |
| Buck Switch Current Limit | I _{DSLIM} | | 1.0 | 1.2 | 2.2 | Α |
| DC-to-DC Fixed Off-Time | t _{OFF} | V _{BB} = 14 V | _ | 4.75 | _ | μs |
| Soft Start Time | t _{SS} | V _{BB} = 14 V | 5 | 10 | 15 | ms |
| Logic Inputs | | , | | | | |
| ENBAT Logic Input Voltage | V _{ENBAT} | HIGH input level | 2.7 | _ | 45 | V |
| ENBAT Logic Input Voltage | | LOW input level | -0.3 | _ | 0.8 | V |
| | I _{ENBAT} | HIGH input level, V _{ENBAT} = 45 V | _ | _ | 300 | μΑ |
| ENBAT Input Current | | HIGH input level, V _{ENBAT} = 14 V | _ | _ | 70 | μA |
| | | LOW input level, V _{ENBAT} = 0.8 V | -1 | _ | 10 | μA |
| ENB Logic Input Voltage | \/ | HIGH input level | 2.7 | _ | 6.5 | V |
| LIND Logic Input Voltage | V _{ENB} | LOW input level | -0.3 | _ | 0.8 | V |
| END Input Current | | HIGH input level, V _{ENB} ≥ 2.7 V | _ | _ | 50 | μA |
| ENB Input Current | I _{ENB} | LOW input level, V _{ENB} ≤ 0.8 V | -1 | _ | 10 | μA |
| Linear Regulator Outputs* | | | | | | |
| V5D Output Voltage | V _{OUTV5D} | 1 mA ≤ I _{LOADV5D} ≤ 200 mA | 4.9 | 5.0 | 5.1 | V |
| V5A Output Voltage | V _{OUTV5A} | 1 mA ≤ I _{LOADV5A} ≤ 200 mA | 4.9 | 5.0 | 5.1 | V |
| V33 Output Voltage | V _{OUTV33} | | 3.234 | 3.300 | 3.366 | V |
| V5A to V5D Tracking | V _{TRACK} | 50 mA \leq I _{LOADV5A} , I _{LOADV5D} \leq 200mA; V _{BB} > 6.5 V | -25 | _ | 25 | mV |
| V5D Current Limit | I _{OUTV5DLIM} | | 200 | 300 | _ | mA |
| V5A Current Limit | I _{OUTV5ALIM} | | 200 | 300 | _ | mA |
| Base Drive Output Current | I _{BD} | 1 V ≤ V _{OUTVADJ} , V _{OUTV33} ≤ 4 V | 5.0 | 10.0 | 16.0 | mA |
| Feedback Voltage | V _{FB} | 33.7.50 | 1.16 | 1.20 | 1.24 | V |
| Feedback Input Bias Current | I _{FB} | | -400 | -100 | 100 | nA |

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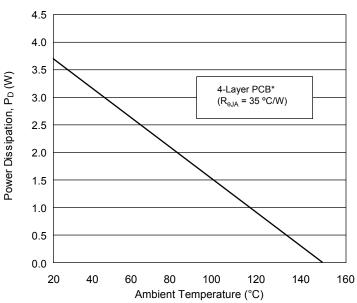


ELECTRICAL CHARACTERISTICS (continued) at $T_A = -40$ °C to 135°C, $V_{BB} = 6$ to 45 V, $V_{ENB} = 5$ V, unless otherwise noted

| Characteristics | Symbol | Test Conditions | Min. | Тур. | Max. | Units |
|--|-----------------------|---|------|------|------|-------|
| Protection | | | | | | |
| NFAULT, NPOR Output Voltage | V _{ERRON} | Fault asserted; I _{NFAULT} , I _{NPOR} = 1 mA | _ | _ | 400 | mV |
| NFAULT, NPOR Leakage Current | I _{ERROFF} | V _{NFAULT} , V _{NPOR} = 5 V | _ | _ | 1 | μA |
| POR Delay | t _{POR} | C9 = 0.47 µF | 65 | 100 | 135 | ms |
| V33 Undervoltage Threshold | V _{UVLOV33} | V ₃₃ rising | 2.80 | 2.95 | 3.10 | V |
| v33 Ondervoltage Threshold | | V ₃₃ falling | 2.75 | 2.90 | 3.05 | V |
| V33 Hysteresis | V _{HYSV33} | | _ | 80 | _ | mV |
| V5A, V5D Undervoltage Threshold | V _{UVLOV5} | V5A, V5D rising | 4.36 | 4.50 | 4.75 | V |
| VSA, VSD Officervoltage Threshold | | V5A, V5D falling | 4.24 | 4.38 | 4.63 | V |
| V5A, V5D Hysteresis | V _{HYSV5} | | _ | 125 | _ | mV |
| VADJ Undervoltage Threshold | V _{UVLOVADJ} | V _{FB} rising | 1.02 | 1.07 | 1.12 | V |
| VAD3 Ondervoltage Threshold | | V _{FB} falling | 0.97 | 1.02 | 1.07 | V |
| VADJ Hysteresis | V _{HYSVADJ} | At FB pin | _ | 70 | - | mV |
| VADJ, V33 Overcurrent Threshold | V _{oc} | | 175 | 200 | 225 | mV |
| VREG Undervoltage Threshold | V _{UVLOVREG} | | 4.94 | 5.15 | 5.36 | V |
| Thermal Warning Threshold T _{JTW} | | T _J rising | _ | 160 | - | °C |
| Thermal Shutdown Threshold T _{JTSD} | | T _J rising | _ | 175 | - | °C |
| Thermal Shutdown Hysteresis T _{HYSTS} | | Recovery period = T _{JTSD} – T _{JTW} | - | 15 | - | °C |

^{*}Linear regulator output specifications are only valid when V_{REG} is in regulation ($V_{BB} \ge 6.5$).

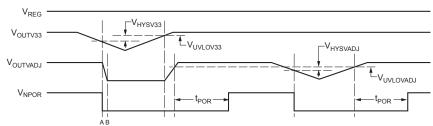
Power Dissipation Versus Ambient Temperature



*In still air; mounted on PCB based on JEDEC high-conductance standard PCB (JESD51-7; High Effective Thermal Conductivity Test Board for Leaded Surface Mount Packages); data on other PCB types is provided on the Allegro Web site.

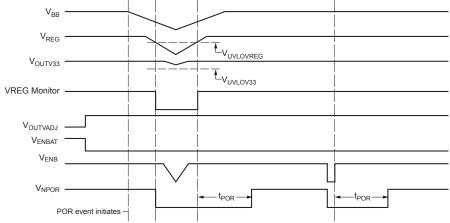


Timing Diagrams



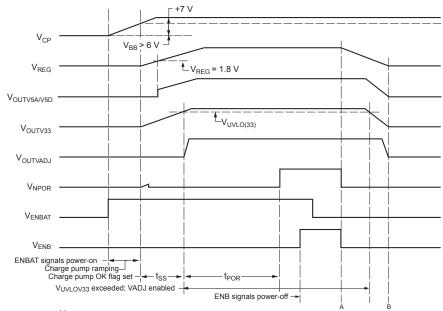
 $$\rm A\,B$$ Slope of $\rm V_{OUTV33}$ and $\rm V_{OUTVADJ}$ from A to B determined by $\rm I_{LOAD}$ and output capacitor (C3, C4).

Figure 1a. NPOR fault due to undervoltage lockout on the V33 or FB pins



V33 can sustain regulation with normal load by bulk capacitor (COUT) on V_{REG}.

Figure 1b. Power-off using V_{BB}



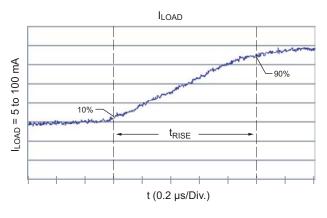
Slope of V_{REG} (which controls $V_{OUTV5AV5D}$, V_{OUTV33} , and $V_{OUTVADJ}$) from A to B determined by I_{LOAD} and COUT.

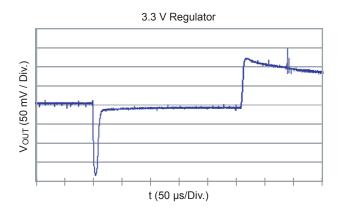
Figure 1c. Power-on using ENBAT, followed by power-off using ENB

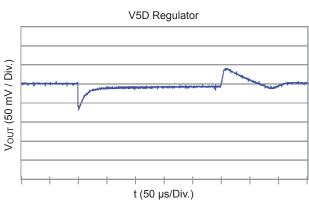


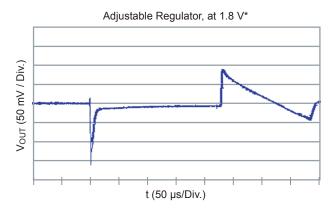
Load Transients Diagrams

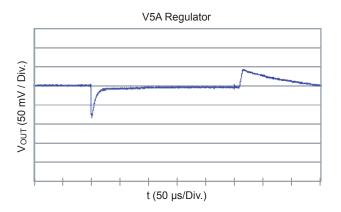
 V_{IN} = 12 V; I_{LOAD} = 100 mA; T_A = 25°C; ac-coupled; C1, C2, C3 and C4 = 1 μ F











*For the adjustable regulator, the transient load response is improved as the voltage is reduced. This is due to the ability of the regulator to provide more base drive (VADJBD) because of more available voltage. When the adjustable regulator approaches 3.3 V, its transient load response is equivalent to the response of the V33 regulator.

For all regulators, load transients can be improved by increasing the output capacitance (C1, C2, C3, and C4). In order to keep ESR down it is best to use ceramic type capacitors. However, large values in ceramic type capacitors are either not available or very expensive. If larger values are needed, above 22 μF , electrolytic capacitors with low ESR ratings can be used. Performance can be improved further by adding a 1 μF ceramic in parallel with the electrolytic.

Functional Description

Buck Converter with Switching Regulator. A current-

mode, variable frequency buck DC-to-DC converter and switching regulator are integrated in the A8450, as shown in figure 2. This feature allows the device to efficiently handle power over a wide range of input supply levels. The DC-to-DC converter outputs 5.7 V typical, and has an overcurrent limit of 1.2 A typical.

The converter employs a soft-start feature. This ramps the converter output voltage and limits the maximum demand on V_{REG} by controlling the inrush current required at power-on to charge the external capacitor, COUT, and any DC load.

An internal charge pump provides gate drive for the N-channel MOSFET buck switch. A 100% duty cycle is implemented when using low V_{BB} input voltages.

At V_{BB} lower than 12 V, off-time, t_{OFF} , is reduced, as shown in figure 3. This reduction keeps the switching frequency, f_{PWM} , within a reasonable range and lowers the ripple current. Lowering the ripple current at low V_{BB} levels prevents degradation of linear regulator headroom due to V_{REG} ripple voltage.

5 V Linear Regulators. Two 5 V medium-power linear regulators are provided. These low-dropout regulators feature foldback current limiting for short-to-ground protection. When a direct short is applied to the regulator output, either V5A or V5D, the current folds back

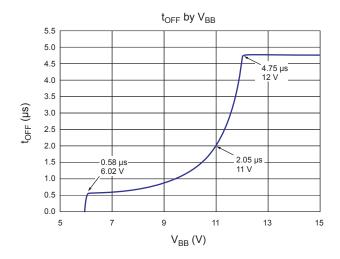


Figure 3. When VBB falls below 12 V, t_{OFF} decreases

L1 100 µH

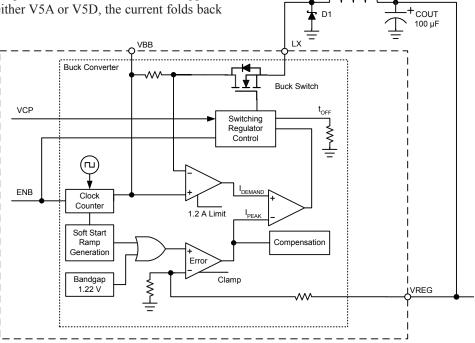


Figure 2. Buck converter with switching regulator



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to 0 V at 50 mA, as shown in figure 4a. The voltage recovers to its regulated output when the short is removed.

The V5A and V5D regulators track each other during power-on, and when the device is enabled and ramped up out of disabled mode, the regulators will start to track when V_{REG} reaches approximately 1.8 V. These regulators are guaranteed to track to within 0.5% of each other under normal operating conditions.

3.3 V and Adjustable Linear Regulators. Two additional linear regulators, one that outputs at 3.3 V, and another that has a 1.2 V to 3.3 V adjustable output, can be implemented using external npn pass transistors. The output voltage of the adjustable regulator, $V_{OUTVADJ}$ (V), is set by the values of the output resistors, R1 and R2 (Ω). It can be calculated as

$$V_{\text{OUTVADJ}} = V_{\text{FB}} (1+R1/R2)$$

where $V_{FB}(V)$ is the voltage on the feedback pin, FB.

Additional pins, CL33 and CLADJ, are provided for setting current limits. These are used to protect the external pass transistors from a short-to-ground condition. The current limit setting, I_{CL} (mA), is calculated using the formula

$$I_{\rm CL} = V_{\rm OC}/R_{\rm RCL}$$

where RCL (Ω) is the current-limiting resistor corresponding to that regulator (R3 for the 3.3 V regulator, and R4 for the adjustable regulator). When I_{CL} is exceeded, the maximum load current through that regulator is folded back to 40% of $I_{CL}\pm10\%$, as shown in figure 4b. If current limiting is not needed, the CL33 and CLADJ pins should be shorted to the VREG pin.

Disabled Mode. When the two input signal pins, ENBAT and ENB, are pulled low, the A8450 enters disabled mode. This is a sleep mode, in which all internal circuitry is disabled in order to draw a minimal current from VBB. When either of these pins is pulled high, the device is enabled. When emerging from disabled mode, the buck converter switching regulator does not operate until the charge pump has stabilized ($\approx 300~\mu s$).

Enabled Mode. When one or both of the signal input pins, ENBAT and ENB, are in the high state, the A8450 is enabled. ENBAT is an edge-triggered enable (logic $1 \ge 2.7$ V), which is used to enable the A8450 in response to a high-voltage signal, such as from an automobile ignition or battery switch. In this capacity, ENBAT is used only as a momentary switch to wake up the device. If there is no need for a high-voltage signal, ENBAT can be pulled low continuously.

ENB is used to initiate the reset of the device. If ENBAT is pulled

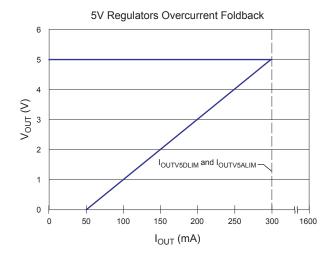


Figure 4a. Linear foldback to 50 mA. Foldback occurs at the typical current limit for the 5 V regulator.

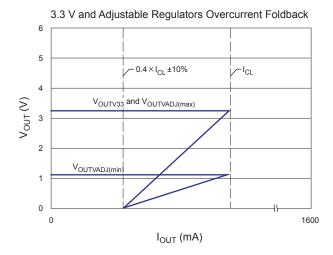


Figure 4b. Linear foldback to a percentage of I_{CL} . Foldback occurs at the current limit setting for the regulator.



low, ENB acts as a single reset control.

Diagnostics. An open drain output, through the NFAULT pin, is pulled low to signal to a DSP or microcontroller any of the following fault conditions:

- V5A, the 5 V analog regulator output, is shorted to supply
- \bullet Either or both of the V5A and the V5D regulator outputs are below their UVLO threshold, V_{UVLOV5}
- \bullet Device junction temperature, $T_{J},$ exceeds the Thermal Warning threshold, T_{JTW}

Charge Pump. The charge pump generates a voltage above V_{BB} in order to provide adequate gate drive for the N-channel buck switch. A 0.1 μF ceramic monolithic capacitor, C7, should be connected between the VCP pin and the VBB pin, to act as a reservoir to run the buck converter switching regulator.

 V_{CP} is internally monitored to ensure that the charge pump is disabled in the case of a fault condition. In addition, a 0.1 μF ceramic monolithic capacitor, C8, should be connected between CP1 and CP2.

Power On Reset Delay. The POR block monitors the supply voltages and provides a signal that can be used to reset a DSP or microcontroller. A POR event is triggered by any of the following conditions:

- Either V33 or VADJ is pulled below its UVLO threshold, $V_{\rm UVLOV33}$ or $V_{\rm UVLOVADJ}$. This occurs if the current limit on either regulator, $V_{\rm OC}$, is exceeded. It also occurs if the VREG voltage falls below $V_{\rm REGMON}$, due to current exceeding $I_{\rm DSLIM}$.
- Both input signal pins, ENB and ENBAT, are pulled low.
 This immediately pulls the NPOR pin low, indicating that the device is beginning a power-off sequence. In addition, the buck

converter switching regulator is disabled, and the VREG supply begins to ramp down. The rate at which V_{REG} decays is dependent on the total current draw, I_{LOAD} , and value of the output capacitors (C1, C2, C3, and C4).

- V_{REG} drops below its UVLO threshold, V_{UVLOVREG}.
- During any normal power-on, V_{OUTVADJ} falls below V_{UVLOVADJ}, triggering a POR.

An open drain output, through the NPOR pin, is provided to signal a POR event to the DSP or microcontroller. The reset occurs after an adjustable delay, $t_{\rm POR}$, set by an external capacitor, C9, connected to the CPOR pin. The value of $t_{\rm POR}$ (ms) is calculated using the following formula

$$t_{POR} = 2.13 \times 10^5 \times C_{CPOR}$$

where C_{CPOR} (μF) is the value of the C9 capacitor.

A POR can be forced without a significant drop in the supply voltage, V_{REG} , by pulsing low both the ENB and the ENBAT pins. However, pulse duration should be short enough so that V_{REG} does not drop significantly.

Thermal Shutdown. When the device junction temperature, T_J , is sensed to be at T_{JTSD} (≈ 15 °C higher than the thermal warning temperature, T_{JTW}), a fault is indicated at the NFAULT pin. At the same time, a thermal shutdown circuit disables the buck converter, protecting the A8450 from damage.



Application Information

Component Selection

Output Inductor (L1). This inductor must be rated to handle the total load current, I_{LOAD} . In addition, the value chosen must keep the ripple current to a reasonable level. A typical selection is a power inductor rated at $100~\mu H$ and 1.3~A.

The worse case ripple current, $I_{RIPPLE(max)}$ (mA), can be calculated as

$$I_{\text{RIPPLE(max)}} = V_{\text{L1OFF}} \times t_{\text{OFF}} / L_{\text{L1}}$$

where L_{L1} (μH) is the inductance for the selected component, and V_{L1OFF} is the voltage (V) through the inductor when the A8450 is in the quiescent state

$$V_{\text{L1OFF}} = V_{\text{REG(max)}} + V_{\text{D1}} + (I_{\text{LOAD}} \times R_{\text{L1}})$$

where $V_{D1}\,$ (V) is the voltage drop on diode D1, $I_{LOAD}\,$ (mA) is the total load current, and R_{L1} is the specified DC resistence (Ω) for the selected inductor at its rated temperature.

The frequency, f_{PWM} (Hz), of the switching regulator in the buck converter can then be estimated by

$$f_{\text{PWM}} = 1/(t_{\text{ON}} + t_{\text{OFF}})$$

where t_{ON} (μ s) is calculated as

$$t_{\rm ON} = I_{\rm RIPPLE(max)} \times L_{\rm L1} / V_{\rm L1ON}$$

and V_{L1ON} (V) as

$$V_{\text{LION}} = V_{\text{BB}} - (I_{\text{LOAD}} \times R_{\text{DSON(max)}})$$
$$- (I_{\text{LOAD}} \times R_{\text{LI}}) - V_{\text{REG(max)}}$$

Example

Given a typical application with V_{BB} = 14 V, t_{OFF} = 4.75 μ s, and I_{LOAD} = 550 mA. (Note that the value for t_{OFF} is constant for V_{BB} > 12 V, as shown in figure 3.)

Given also a 100 μ H power inductor rated at 400 m Ω for 125°C. (Note that temperature ratings for inductors may include self-heating effects. If a 125°C rating includes a self-heating temperature rise of 20°C at maximum current, then the actual ambient temperature, T_A , cannot exceed 105°C.)

$$V_{L1OFF} = 5.8 + 0.8 + (0.550 \times 0.400) = 6.821 \text{ V}$$
 $I_{RIPPLE(max)} = 6.821 \times 4.75 / 100 = 0.324 \text{ A}$
 $V_{L1ON} = 14 - (0.550 \times 0.750) - (0.550 \times 0.400)$
 $-5.8 = 7.56 \text{ V}$

$$t_{ON} = 0.324 \times 100 / 7.56 = 4.3 \mu s$$

 $f_{PWM} = 1/(4.3 + 4.75) = 111 \text{ kHz}$

In the case of a shorted output, the buck converter could reach its internal current limit, $I_{DSLIM},$ of 1.2 A typical. To ensure safe operation, the I_{SAT} rating for the selected inductor should be greater than 1.4 A. However, if the external current limit resistors, R3 and R4, selected for the 3.3 V and adjustable (1.2 V to 3.3 V) regulators, are rated such that the total inductor current, $I_{LOAD},$ could never reach that internal current limit, then an inductor can be selected that has an I_{SAT} rating closer to the calculated output current of the device, $I_{LOAD},$ plus the maximum ripple current, $I_{RIPPLE(max)}.$

Higher inductor values can be chosen to lower I_{RIPPLE} . This may be an option if it is desired to increase the total maximum current that is drawn from the switching regulator. The maximum total current available, I_{LOAD} (mA), is calculated as

$$I_{\text{LOAD}} = I_{\text{DSLIM}} - (I_{\text{RIPPLE(max)}}/2)$$

Catch Diode (D1). The Schottky catch diode should be rated to handle 1.2 times the maximum load current, I_{LOAD} , because the duty cycle at low input voltages, V_{BB} , can be very close to 100%. The voltage rating should be higher than the maximum input voltage, $V_{BB(max)}$, expected during any operating condition.

VREG Output Capacitor (COUT). Voltage ripple in the VREG output is the main consideration when selecting the VREG output capacitor, COUT. The peak-to-peak output voltage ripple, $V_{RIPPLE(p-p)}$ (mV), is calculated as

$$V_{\text{RIPPLE(p-p)}} = I_{\text{RIPPLE}} \times \text{ESR}_{\text{COUT}}$$

with ESR in ohms. It is recommended that the maximum level of $V_{RIPPLE(p-p)}$ be less than 200 mV.

For electrolytic output capacitors, a low-ESR type is recom-



mended, with a minimum voltage rating of 10 V. However, because ESR decreases with voltage, the most cost-effective choice may be a capacitor with a higher voltage rating.

Regulator Output Capacitors (C3 and C4). The output capacitors used with the 3.3 V regulator (C3) and the 1.2 V to 3.3 V adjustable regulator (C4), should be 1 μ F or greater X7R (5% tolerance) ceramic or equivalent capacitors, with a maximum capacitance change of $\pm 15\%$ over a temperature range of -55° C to 125° C.

The ESR of these capacitors does not affect the outputs of the corresponding regulators. If a greater capacitance is used, the regulators have improved ripple rejection at frequencies greater than 100 kHz.

Pass Transistors (Q1 and Q2). The pass transistors used to implement the 3.3 V regulator and the 1.2 V to 3.3 V adjustable regulator must ensure the following:

• **Stable operation.** The cutoff frequency for the control loops of the regulators is 100 kHz. Transistors must be selected that have gain bandwidth product, f_T (kHz), and beta, h_{FE} (A), ratings such that

$$f_T / h_{FE} > 100 \text{ kHz}$$

• Adequate base drive. It is acceptable to use a lower level of current gain, h_{FE} , for lower total load currents, I_{LOAD} . The lower limit for I_{LOAD} is limited by the minimum base current for the A8450, $I_{BD(min)}$, and the minimum h_{FE} of the pass transistor, such that

$$I_{\text{LOAD}} = I_{\text{BD(min)}} \times h_{\text{FE(min)}}$$

Note that h_{FE} is dependant on operating temperature. Lower temperatures decrease h_{FE} , affecting the current capacity of the transistor.

• Packaged for sufficient power dissipation. In order to ensure appropriate thermal handling, the design of the application must take into consideration the thermal characteristics of the PCB where the A8450 and pass transistors are mounted, the ambient temperature, and the power dissipation characteristics of the transistor packages. In general, the power dissipation, P_D (mW), is estimated by

$$P_{\rm D} = (V_{\rm REG} - V_{\rm OUT}) \times I_{\rm LOAD}$$

For a typical application where $V_{REG} = 5.8 \text{ V}$, $V_{OUT} = 2.5 \text{ V}$, and $I_{LOAD} = 190 \text{ mA}$

$$P_D = (5.8 - 2.5) \times 190 = 627 \text{ mW}$$

Adjusting Pass Transistor Power Dissipation

Transistors are manufactured in a wide variety of package types, and the thermal dissipation efficiencies of the packages can vary greatly. In general, increasing thermal efficiency can also increase cost substantially. Selecting the package to closely match operating conditions is important to optimizing application design and cost.

Even when using a thermally-enhanced package, it remains difficult to provide high current to a load at high ambient operating temperatures. Depending on the load requirements, using drop resistors, as shown in figure 5, may be necessary to protect the pass transistor from overheating.

The output current-limiting resistors, RCL (corresponding to R3 and R4), will drop between 175 mV and 225 mV at the highest current output, I_{LOAD} . Assuming no additional resistance, the voltage dropped, V_{DROP} (mV), on each pass transistor is

$$V_{\text{DROP}} = V_{\text{REG}} - V_{\text{RCL}} - V_{\text{OUT}}$$

This can be substituted into the power dissipation formula

$$P_{\rm D} = V_{\rm DROP} \times I_{\rm LOAD}$$

Given a typical application where V_{REG} = 5.8 V, V_{RCL} = 0.175 V, V_{OUT} = 3.3 V, and I_{LOAD} = 350 mA, then P_D is approximately 814 mW.

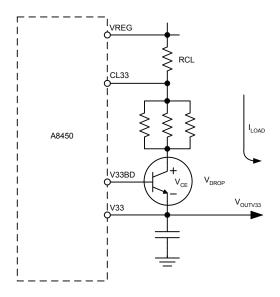


Figure 5. Placement of drop resistors for thermal protection; example shown is for the 3.3 V regulator.



 P_D can be used to estimate the minimum required operating temperature rating for the transistor. The ability of a package to dissipate heat is approximated by the thermal resistance from the die (junction) to the ambient environment, $R_{\theta JA}$ (°C/W). This includes the significant effect of dissipation through the package leads and the PCB on which the transistor is mounted, and the state of the ambient air. The typical rating for a DPAK package is 32°C/W. The expected self-induced temperature rise in the package, ΔT_J (°C), given P_D = 0.814 W, is approximated as

$$\Delta T_{\rm J} = P_{\rm D} \times R_{\rm \theta JA} = 26^{\circ} C$$

In automotive applications, where under-the-hood ambient temperatures can exceed 125°C, the pass transistor would have to be rated to provide the required beta at \geq 151°C, plus a safe operating margin.

For a selected transistor, V_{CE} can change depending on current, temperature, and transistor beta. Typically, transistors are rated at a minimum beta at a defined V_{CE} . However, V_{CE} should be calculated with some margin so there is always enough headroom to drive the device at the desired load.

To provide an operating margin, or if a lower-value RCL is required, voltage drop resistors, RDROP, can be added to the circuit, between the RCL and the transistor (figure 5). It is also important to consider tolerances in resistance values and V_{REG} . The level of $V_{REG(min)}$ is 5.6 V, at which level P_D is reduced, but also the voltage available for V_{CE} is reduced. Calculating maximum and minimum voltage drops is useful in determining the values of the drop resistors.

The required drop resistor value, R_{RDROP}, can be determined in terms of the voltage drops across each component of the circuit, as shown in the following formula

$$V_{\text{DROP}} \geq V_{\text{OUT}}$$

where

$$V_{\text{DROP}} = V_{\text{REG}} - V_{\text{RCL}} - V_{\text{RDROP}} - V_{\text{CE}}$$

Assume that $V_{REG(max)}$ = 5.8 V and $V_{OUT(max)}$ = 3.3 V. Assume also that T_A = 125°C, and V_{CE} = 1V (as specified for the MPSW06 npn transistor, beta = 300 at 125°C).

In order to determine the resistance values for the current-limiting and drop resistors, V_{RCL} and V_{DROP} can be expressed in terms of $I_{LOAD(lim)}$

$$V_{\text{RCL}} = (I_{\text{LOAD(lim})} \times R_{\text{CL}})$$

$$V_{\text{RDROP}} = (I_{\text{LOAD(lim})} \times R_{\text{RDROP}})$$

Assume a typical I_{LOAD} = 350 mA. However, under normal operating conditions, the current limit set by RCL would be higher than the expected normal current, so assume $I_{LOAD(lim)}$ = 0.400 A and R_{CL} = 44 Ω . Substituting to determine V_{RCL}

$$V_{\rm RCL} = 0.400 \times 0.44 = 0.176 \,\rm V$$

We can now solve for R_{RDROP} and then V_{DROP}

$$V_{REG} - V_{RCL} - (I_{LOAD} \times R_{RDROP}) - V_{CE} \ge V_{OUT}$$

5.8 - 0.176 - (0.4 × R_{RDROP}) - 1 \ge 3.30 V

therefore

$$R_{\rm RDROP} \ge 3.31 \ \Omega$$

and

$$V_{\text{RDROP}} = 0.4 \times 3.31 = 1.3 \text{ V}$$

Using four 0.25 W resistors valued at 14.7 Ω in parallel will drop 1.3 volts.

Using the drop resistors as calculated above, the power dissipation in the transistor, P_D (W) is reduced to

$$P_{\rm D} = I_{\rm LOAD(lim)} \times (V_{\rm REG} - V_{\rm RCL} - V_{\rm RDROP} - V_{\rm OUT})$$

= 0.400×(5.8 - 0.176 - 1.3 - 3.3) = 0.410 W

and

$$\Delta T_{\rm I} = P_{\rm D} \times R_{\rm HIA} = 13^{\circ} C$$

The power dissipated in the transistor is significantly reduced. A transistor in a power package with an $R_{\theta JA}$ of $32^{\circ} C/W$ at 400 mA (a 50 mA margin) undergoes a temperature rise of $13^{\circ} C$ with the drop resistors, as opposed to a similar transistor at 350 mA rising $26^{\circ} C$ without drop resistors. At high output currents, properly selected drop resistors can protect the external pass transitor from overheating.

A8450 Power Dissipation. The A8450 is designed to operate in applications with high ambient temperatures. The total power dissipated in the device must be considered in conjunction with the thermal dissipation capabilities of the PCB where the A8450 is mounted, as well as the capabilities of the device package itself.

The ability of a package to dissipate heat is approximated by the thermal resistance from the die (junction) to the ambient environment, $R_{\theta JA}$ (°C/W). This includes the significant effect of dissipation through the package leads and the PCB on which the package is mounted, and the temperature of the ambient air.



Test results for this 24-lead SOIC are approximately 35 °C/W when mounted on a high-thermally conductive PCB (based on the JEDEC standard PCB, having four layers with buried copper

The total power that can be applied to the device, $P_{D(lim)}(W)$, is affected by the maximum allowable device junction temperature, $T_{J(max)}$ (°C), $R_{\theta JA}$, and the ambient air temperature, T_A (°C), as shown in the following formula

$$P_{D(lim)} = (T_{J(max)} - T_A) / R_{\theta JA}$$

P_{D(lim)} can be estimated based on several parameters, using the following formula

$$\begin{aligned} P_{D(lim)} &&= P_{D(lbias)} + P_{D(V5A)} + P_{D(V5D)} + P_{D(buckdc)} \\ &&+ P_{D(buckac)} + P_{D(BD)} \end{aligned}$$

where

$$P_{D(Ibias)} = V_{BB} \times I_{BB}$$

$$P_{D(V5A)} = (V_{REG} - 5 V) \times I_{LOAD(V5A)}$$

$$P_{D(V5D)} = (V_{REG} - 5 V) \times I_{LOAD(V5D)}$$

$$P_{D(buckdc)} = I_{LOAD}^2 \times R_{DSON(TJmax)} \times DC$$

$$P_{D(buckac)} = I_{LOAD} \times [V_{BB}(5 \text{ ns}/14 \text{ V}) \times V_{BB}] \times 0.5 f_{PWM}$$

$$P_{D(BD)} = I_{V33BD(max)} \times (V_{REG} - 4V) + I_{VADJBD(max)}$$

$$\times (V_{REG} - V_{ADI} - 0.7 V)$$

and

$$I_{LOAD} = I_{LOAD(V33)} + I_{LOAD(VADJ)} + I_{LOAD(V5D)} + I_{LOAD(V5A)}$$

 R_{DSON} is a function of T_J . For the purposes of estimating $P_{D(lim)}$, the relationship can be assumed to be linear throughout the practical T_I operating range (see test conditions for R_{DSON} in the Electrical Characteristics table).

DC (duty cycle) is a function of V_{BB} and $V_{REG}. \label{eq:decomposition}$ This can be calculated precisely as

$$DC = V_{REG(off)} / (V_{REG(on)} + V_{REG(off)})$$

A rough estimate for DC is

$$DC = (V_{REG} + V_{LX}) / V_{BB}$$

 $I_{V33BD(max)}$ is the maximum current drawn on the V33BD pin. It is dependent on I_{OUTV33} and the h_{FE} of the pass transistor.

 $I_{ADJBD(max)}$ is the maximum current drawn on the VADJBD pin.

It is dependent on $I_{OUTVADI}$ and the h_{FE} of the pass transistor.

Overcurrent Protection

The current supplied by the 3.3 V and the 1.2 to 3.3 V adjustable regulators is limited to I_{CL}. Current above I_{CL} is folded back linearly, as shown in figure 4b. In the case of a shorted load, the collector current is reduced to 40% of $I_{CL} \pm 10\%$, to ensure protection of the pass transistors. After the short is removed, the voltage recovers to its regulated level.

The maximum power dissipated in the transistor during a shorted load condition is:

$$P_{\rm D} \approx (V_{\rm REG} - V_{\rm OUT}) \times (0.4 \times I_{\rm CL})$$

where $V_{OLIT} = 0 \text{ V}$.

Low Input Voltage Operation

When the charge pump has ramped enough to enhance the buck switch, the buck converter switching regulator is enabled. This occurs at $V_{BB} \approx 5.7$ V. At that point, the duty cycle, DC, of the A8450 can be forced to 100% until V_{IN} is high enough to allow the switch to begin operating normally. The point at which normal switching begins is dependent on ambient temperature, T_{Δ} . Increases in T_A cause R_{DSON} to increase. Other significant factors are I_{LOAD}, V_{REG}, the ESR of the output inductor (L1), and the forward biasing voltage for the output Schottky diode (D1).

Regulator Bypass

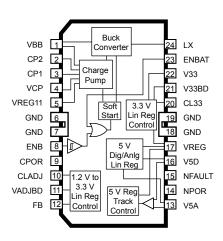
Some applications may not require the use of all four regulators provided in the A8450. For the regulators that are not used, the corresponding external components are not needed.

If either or both of the two 5 V regulators are not required by the application, bypass an unused regulator by not connecting its output terminal, V5D or V5A. Also, the corresponding output capacitor, C1 or C2, is not used.

For the 3.3 V regulator and the 1.2 V to 3.3 V adjustable regulator, if either or both are not needed, the corresponding external components are not used. In addition, if the 3.3 V regulator is not used, CL33 and V33 are not connected. If the adjustable regulator is not used, CLADJ and FB are not connected. However, to ensure stability of the A8450, the base drive pin, V33BD or VAD-JBD, of any unused regulator must be shorted to VREG.



Pin-Out Diagram

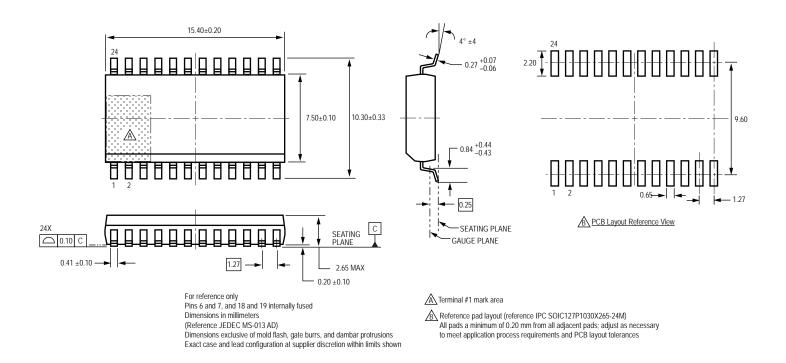


Terminal List Table

| Name | Description | Number |
|--------|--|--------|
| VBB | Supply input | 1 |
| CP2 | Charge pump capacitor, positive side | 2 |
| CP1 | Charge pump capacitor, negative side | 3 |
| VCP | Charge pump output used to drive N-channel buck converter transistor | 4 |
| VREG11 | Internal reference | 5 |
| GND | Power ground | 6 |
| GND | Power ground | 7 |
| ENB | Logic control | 8 |
| CPOR | Connection for POR adjustment | 9 |
| CLADJ | Current limit for adjustable regulator | 10 |
| VADJBD | ADJBD Base drive for adjustable regulator pass transistor | |
| FB | FB Feedback for adjustable regulator | |
| V5A | 5 V analog regulator output | 13 |
| NPOR | Power on Reset logic output | 14 |
| NFAULT | Diagnostic output; open drain; low during fault condition | 15 |
| V5D | 5 V digital regulator output | 16 |
| VREG | DC-to-DC converter supply output | 17 |
| GND | Power ground | 18 |
| GND | Power ground | 19 |
| CL33 | CL33 Current limit for 3.3 V regulator | |
| V33BD | Base drive for 3.3 V regulator pass transistor | 21 |
| V33 | 3.3 V regulator output | 22 |
| ENBAT | High voltage logic control | 23 |
| LX | LX Buck converter switching regulator output | |



Package LB, 24-Pin SOICW



Leads 6 and 7, and 18 and 19 are internally fused ground leads, for enhanced thermal dissipation.

A8450

Automotive Multioutput Voltage Regulator

Revision History

| Revision | Revision Date | Description of Revision |
|----------|------------------|-----------------------------|
| Rev. 8 | January 30, 2012 | Update product availability |
| | | |

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